

# STTA5012T(V)1/2

PRELIMINARY DATA

# TURBOSWITCH ™ "A". ULTRA-FAST HIGH VOLTAGE DIODE

#### MAIN PRODUCTS CHARACTERISTICS

I <sub>F(AV)</sub>	25A
V <sub>RRM</sub>	1200V
t <sub>rr</sub> (typ)	65ns
V <sub>F</sub> (max)	1.85V

#### **FEATURES AND BENEFITS**

- ULTRA-FAST, SOFT AND NOISE-FREE RECOVERY.
- VERY LOW OVERALL POWER LOSSES IN BOTH THE DIODE AND THE COMPANION TRANSISTOR.
- HIGH FREQUENCY AND/OR HIGH PULSED CURRENT OPERATIONS.

# STTA5012T(V)1 STTA5012T(V)2 ISOTOP ® (Plastic) Screw version (\*)

#### **DESCRIPTION**

The TURBOSWITCH is a very high performance series of ultra-fast high voltage power diodes from 600V to 1200V.

TURBOSWITCH 1200V drastically cuts losses in all high voltage operations which require extremely fast, soft and noise-free power diodes. Due to their optimized switching performances they also highly decrease power losses in any associated switching IGBT or MOSFET in all "Freewheel

Mode" operations.

They are particularly suitable in Motor Control circuitries, or in the primary of SMPS as snubber, clamping or demagnetizing diodes, and also at the secondary of SMPS as high voltage rectifier diodes.

Packaged in ISOTOP®, this 1200V device is particularly intended for use on 3 phase 400V industrial mains.

#### **ABSOLUTE MAXIMUM RATINGS**

Symbol	Parameter	Value	Unit
$V_{RRM}$	Repetitive peak reverse voltage	1200	V
V <sub>RSM</sub>	Non repetitive peak reverse voltage	1200	V
I <sub>F(RMS)</sub>	RMS forward current	50	Α
I <sub>FRM</sub>	Repetitive peak forward current (tp = 5 $\mu$ s, f = 5kHz)	300	Α
Tj	T <sub>j</sub> Max operating junction temperature		°C
T <sub>stg</sub>	Storage temperature	-65 to 150	°C

<sup>(\*):</sup> Tin plasted Fast-on version is also available (Without V suffix).

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# STTA5012T(V)1/2

## THERMAL AND POWER DATA

Symbol	Parameter	Conditions	Value	Unit
R <sub>th(j-c)</sub>	Junction to case thermal	Per diode	1.4	°C/W
	resistance	Total	0.75	
		Coupling	0.1	
P <sub>1</sub>	Conduction power dissipation (see fig. 6)	$I_{F(AV)} = 25A \delta = 0.5$ Per diode Tc= 70°C	57	W
P <sub>max</sub>	Total power dissipation Pmax = P1 + P3 (P3 = 10% P1)	Per diode Tc= 62°C	62.5	W

# STATIC ELECTRICAL CHARACTERISTICS (see Fig.6)

Symbol	Parameter	Test Conditions		Min	Тур	Max	Unit
V <sub>F</sub> *	Forward voltage drop	I <sub>F</sub> =25A	Tj = 25°C Tj = 125°C			2.1 1.9	V V
I <sub>R</sub> **	Reverse leakage current	V <sub>R</sub> =0.8 x V <sub>RRM</sub>	Tj = 25°C Tj = 125°C			150 8	μA mA

Test pulses widths :  $\,\,^{\star}$  tp = 380  $\mu s,\,duty\,cycle < 2\%$ 

## **DYNAMIC ELECTRICAL CHARACTERISTICS**

# TURN-OFF SWITCHING (see Fig.7)

Symbol	Parameter	Test Conditions	Min	Тур	Max	Unit
t <sub>rr</sub>	Reverse recovery time	Tj = 25°C $I_F = 0.5 \text{ A}$ $I_R = 1 \text{A}$ $Irr = 0.25 \text{A}$ $I_F = 1 \text{ A}$ $dI_F/dt = -50 \text{A}/\mu \text{s}$ $V_R = 30 \text{V}$		60	110	ns
I <sub>RM</sub>	Maximum reverse recovery current	$Tj = 125$ °C VR = 600 V $I_F = 25$ A $dI_F/dt = -200$ A/ $\mu$ s $dI_F/dt = -500$ A/ $\mu$ s		TBD	TBD	А
S factor	Softness factor	$Tj = 125$ °C $V_R = 600V$ $I_F = 25A$ $dI_F/dt = -500$ $A/\mu s$		1.2		/

# TURN-ON SWITCHING (see Fig.8)

Symbol	Parameter	Test Conditions	Min	Тур	Max	Unit
t <sub>fr</sub>	Forward recovery time	Tj = 25°C $I_F = 25$ A, $dI_F/dt = 200$ A/ $\mu$ s measured at, 1.1 × V <sub>F</sub> max			TBD	ns
V <sub>Fp</sub>	Peak forward voltage	Tj = 25°C I <sub>F</sub> =25A, dI <sub>F</sub> /dt = 200 A/μs I <sub>F</sub> =40A, dI <sub>F</sub> /dt = 500 A/μs			TBD TBD	V



<sup>\*\*</sup> tp = 5 ms , duty cycle < 2%

#### **APPLICATION DATA**

The 1200V TURBOSWITCH series has been designed to provide the lowest overall power losses in all high frequency or high pulsed current operations. In such applications (Fig 1 to 5),the way of calculating the power losses is given below .

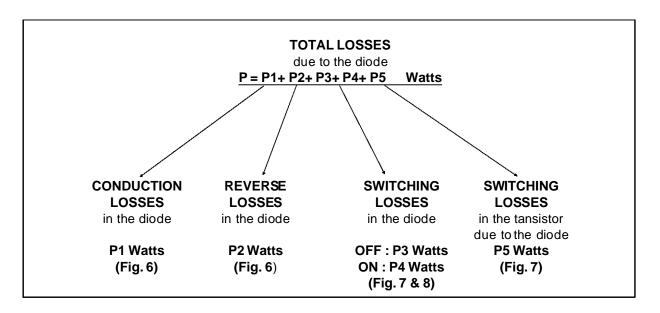


Fig. 1: "FREEWHEEL" MODE.

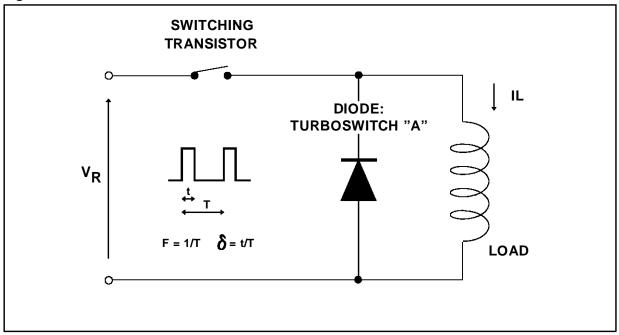


Fig. 2: SNUBBER DIODE.

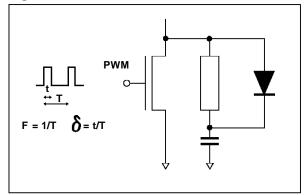


Fig. 3: CLAMPING DIODE.

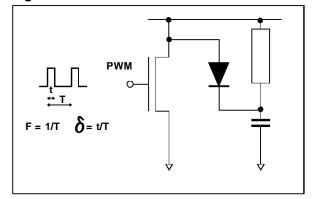


Fig. 4: DEMAGNETIZING DIODE.

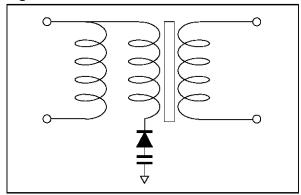
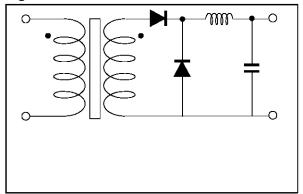
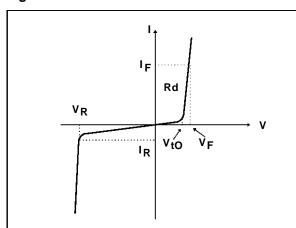


Fig. 5: RECTIFIER DIODE.



## STATIC & DYNAMIC CHARACTERISTICS. POWER LOSSES.

Fig. 6: STATIC CHARACTERISTICS



## **Conduction** losses:

$$\mathsf{P1} = \mathsf{V}_{t0} \;.\; \mathsf{IF}(\mathsf{AV}) \,+\, \mathsf{Rd} \;.\; \mathsf{IF}^2(\mathsf{RMS})$$

with

$$V_{t0} = 1.52 \ V$$
 
$$R_d = 0.015 \ Ohm$$
 (Max values at 125°C,suitable for Ipeak < 3.I<sub>F(av)</sub> )

## Reverse losses:

$$P2 = V_R \cdot I_R \cdot (1 - \delta)$$

#### **APPLICATION DATA (Cont'd)**

Fig. 7: TURN-OFF CHARACTERISTICS

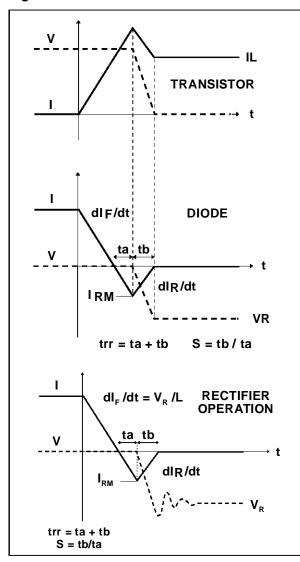
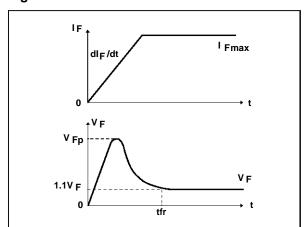


Fig. 8: TURN-ON CHARACTERISTICS



#### Turn-on losses:

(in the transistor, due to the diode)

P5 = 
$$\frac{V_R \times I_{RM}^2 \times (3 + 2 \times S) \times F}{6 \times dI_F / dt} + \frac{V_R \times I_{RM} \times I_L \times (S + 2) \times F}{2 \times dI_F / dt}$$

Turn-off losses (in the diode):

$$P3 = \frac{V_R \times I_{RM}^2 \times S \times F}{6 \times dI_F/dt}$$

## Turn-off losses:

(with non negligible serial inductance)

P3' = 
$$\frac{V_R \times I_{RM}^2 \times S \times F}{6 \times dI_F/dt} + \frac{L \times I_{RM}^2 \times F}{2}$$

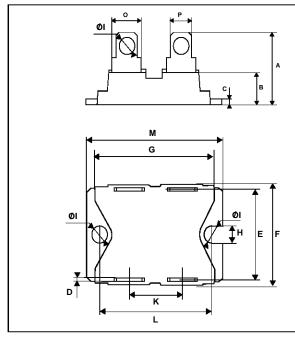
P3,P3' and P5 are suitable for power MOSFET and IGBT

#### Turn-on losses:

$$P4 = 0.4 (V_{FP} - V_{F}) . I_{Fmax} . t_{fr} . F$$

## PACKAGE MECHANICAL DATA

ISOTOP Fast on version



	DIMENSIONS			
REF.	Millimeters		Inch	nesz
	Min.	Max.	Min.	Max.
Α	20.30	20.70	0.799	0.815
В	8.90	9.10	0.350	0.358
С	1.958	2.05	0.078	0.081
D	0.75	0.87	0.029	0.034
Е	22.00	22.40	0.866	0.882
F	25.10	25.50	0.988	1.004
G	31.50	31.70	1.240	1.248
Н	4.00		1.57	
I	4.10	4.30	0.161	0.169
J	2.50	2.60	0.098	1.103
K	14.90	15.10	0.580	0.595
L	30.10	30.30	1.185	1.193
М	37.80	38.20	1.488	1.504
N	4.10	4.30	0.161	0.169
0	7.80	8.20	0.307	0.323
Р	6.20	6.40	0.244	0.252

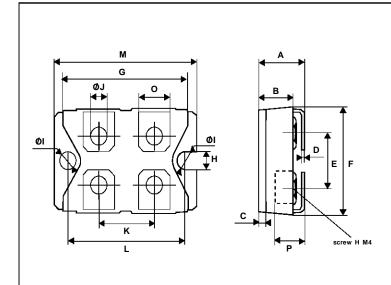
Cooling method : C Marking : Type number

Weight: 28 g

- Recommended torque value : 1.3 N.m (MAX 1.5 N.m) for the 6 x M4 screws. (2 x M4 screws recommended for mounting the package on the heatsink and the 4 screws given with the screw version).
- The screws supplied with the package are adapted for mounting on a board (or other types of terminals) with a thickness of 0.6 mm min and 2.2 mm max.

# PACKAGE MECHANICAL DATA

ISOTOP Screw version



	DIMENSIONS				
REF.	Millim	neters	Inc	hes	
	Min.	Max.	Min.	Max.	
Α	11.80	12.20	0.465	0.480	
В	8.90	9.10	0.350	0.358	
С	1.95	2.05	0.077	0.081	
D	0.75	0.85	0.029	0.034	
Е	12.60	12.80	0.496	0.504	
F	25.10	25.50	0.988	1.004	
G	31.50	31.70	1.240	1.248	
Н	4.00		0.157		
	4.10	4.30	0.161	0.169	
J	4.10	4.30	0.161	0.169	
K	14.90	15.10	0.586	0.595	
L	30.10	30.30	1.185	1.193	
М	37.80	38.20	1.488	1.504	
0	7.80	8.20	0.307	0.323	
Р	5.50		0.216		

Cooling method : C Marking : Type number

Weight: 28 g



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